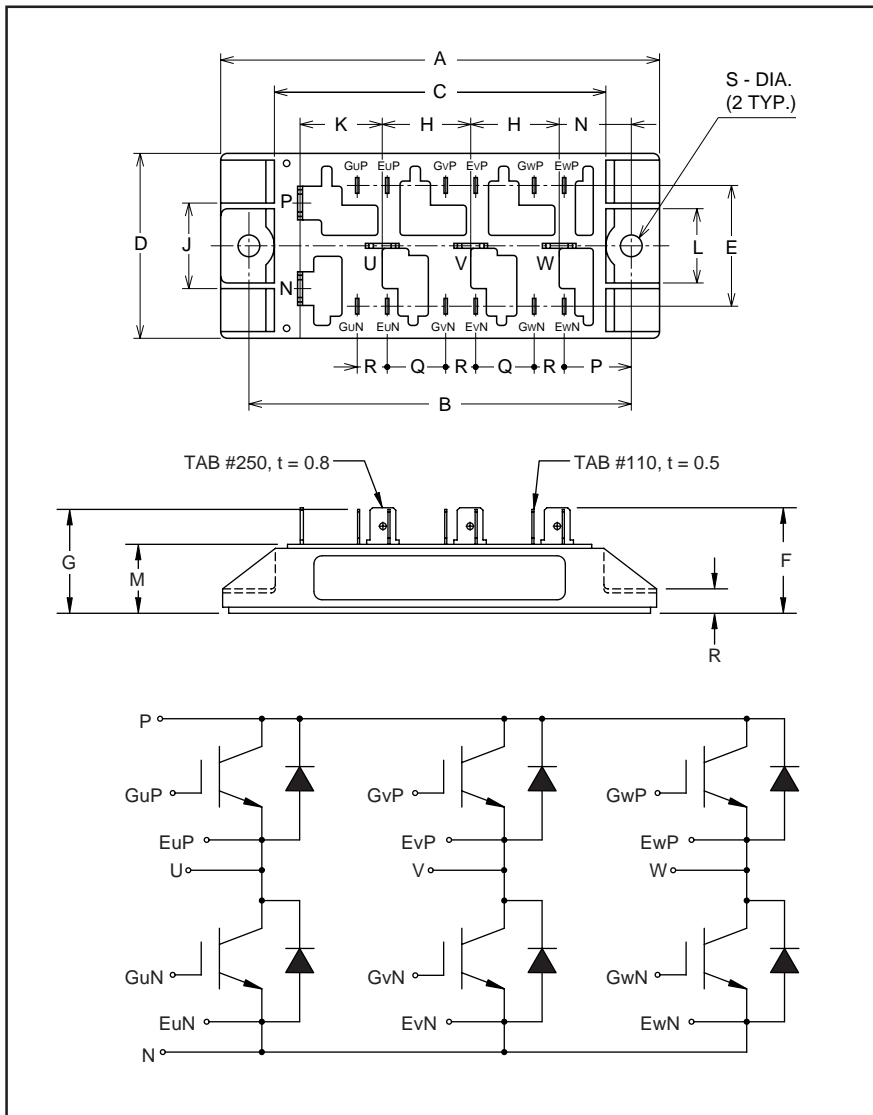


CM30TF-12H

MEDIUM POWER SWITCHING USE
INSULATED TYPE



Description:

Mitsubishi IGBT Modules are designed for use in switching applications. Each module consists of six IGBTs in a three phase bridge configuration, with each transistor having a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- Low Drive Power
- Low $V_{CE(sat)}$
- Discrete Super-Fast Recovery Free-Wheel Diode
- High Frequency Operation
- Isolated Baseplate for Easy Heat Sinking

Applications:

- AC Motor Control
- Motion/Servo Control
- UPS
- Welding Power Supplies

Ordering Information:

Example: Select the complete part module number you desire from the table below -i.e. CM30TF-12H is a 600V (V_{CES}), 30 Ampere Six-IGBT Module.

Type	Current Rating Amperes (30)	V_{CES} Volts (x 50)
CM	30	12

Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	4.21	107.0
B	3.66±0.01	93.0±0.2
C	3.19	81.0
D	1.77	45.0
E	1.18	30.0
F	1.11	28.2
G	1.05	26.6
H	0.85	21.5
J	0.83	21.0

Dimensions	Inches	Millimeters
K	0.79	20.0
L	0.71	18.0
M	0.69	17.5
N	0.69	17.5
P	0.63	16.0
Q	0.55	14.0
R	0.30	7.5
S	0.22 Dia.	Dia. 5.5

CM30TF-12H

MEDIUM POWER SWITCHING USE
INSULATED TYPEAbsolute Maximum Ratings, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

	Symbol	Ratings	Units
Junction Temperature	T_j	-40 to 150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-40 to 125	$^\circ\text{C}$
Collector-Emitter Voltage (G-E SHORT)	V_{CES}	600	Volts
Gate-Emitter Voltage (C-E SHORT)	V_{GES}	± 20	Volts
Collector Current ($T_C = 25\text{ }^\circ\text{C}$)	I_C	30	Amperes
Peak Collector Current	I_{CM}	60*	Amperes
Emitter Current** ($T_C = 25\text{ }^\circ\text{C}$)	I_E	30	Amperes
Peak Emitter Current**	I_{EM}	60*	Amperes
Maximum Collector Dissipation ($T_C = 25\text{ }^\circ\text{C}$, $T_j \leq 150\text{ }^\circ\text{C}$)	P_c	150	Watts
Mounting Torque, M5 Mounting	-	1.47 ~ 1.96	N · m
Weight	-	260	Grams
Isolation Voltage (Main Terminal to Baseplate, AC 1 min.)	V_{iso}	2500	Vrms

*Pulse width and repetition rate should be such that the device junction temperature (T_j) does not exceed $T_{j(\text{max})}$ rating.

**Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDI).

Static Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	I_{CES}	$V_{\text{CE}} = V_{\text{CES}}$, $V_{\text{GE}} = 0\text{V}$	-	-	1.0	mA
Gate Leakage Current	I_{GES}	$V_{\text{GE}} = V_{\text{GES}}$, $V_{\text{CE}} = 0\text{V}$	-	-	0.5	μA
Gate-Emitter Threshold Voltage	$V_{\text{GE(th)}}$	$I_C = 3\text{mA}$, $V_{\text{CE}} = 10\text{V}$	4.5	6.0	7.5	Volts
Collector-Emitter Saturation Voltage	$V_{\text{CE(sat)}}$	$I_C = 30\text{A}$, $V_{\text{GE}} = 15\text{V}$	-	2.1	2.8**	Volts
		$I_C = 30\text{A}$, $V_{\text{GE}} = 15\text{V}$, $T_j = 150\text{ }^\circ\text{C}$	-	2.15	-	Volts
Total Gate Charge	Q_G	$V_{\text{CC}} = 300\text{V}$, $I_C = 30\text{A}$, $V_{\text{GE}} = 15\text{V}$	-	90	-	nC
Emitter-Collector Voltage	V_{EC}	$I_E = 30\text{A}$, $V_{\text{GE}} = 0\text{V}$	-	-	2.8	Volts

** Pulse width and repetition rate should be such that device junction temperature rise is negligible.

Dynamic Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input Capacitance	C_{ies}		-	-	3.0	nF
Output Capacitance	C_{oes}	$V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 10\text{V}$	-	-	1.1	nF
Reverse Transfer Capacitance	C_{res}		-	-	0.6	nF
Resistive Load	Turn-on Delay Time	$t_{\text{d(on)}}$	-	-	120	ns
Switching Times	Turn-off Delay Time	$t_{\text{d(off)}}$	-	-	200	ns
Diode Reverse Recovery Time	t_{rr}	$I_E = 30\text{A}$, $di_E/dt = -60\text{A}/\mu\text{s}$	-	-	110	ns
Diode Reverse Recovery Charge	Q_{rr}	$I_E = 30\text{A}$, $di_E/dt = -60\text{A}/\mu\text{s}$	-	0.08	-	μC

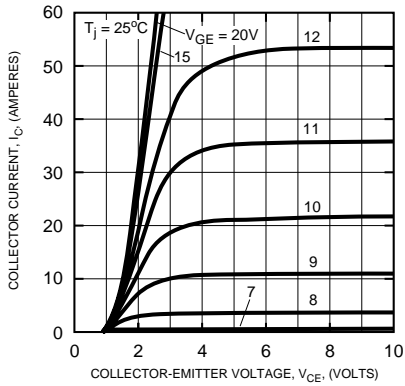
Thermal and Mechanical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case	$R_{\text{th(j-c)}}$	Per IGBT	-	-	0.80	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Case	$R_{\text{th(j-c)}}$	Per FWDi	-	-	2.00	$^\circ\text{C}/\text{W}$
Contact Thermal Resistance	$R_{\text{th(c-f)}}$	Per Module, Thermal Grease Applied	-	-	0.058	$^\circ\text{C}/\text{W}$

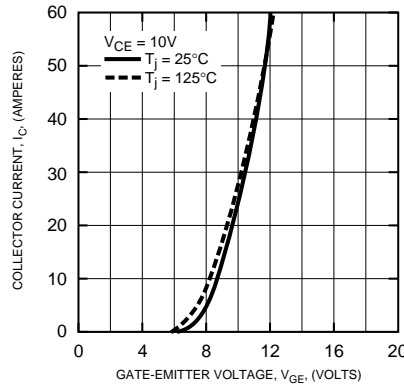
CM30TF-12H

MEDIUM POWER SWITCHING USE
INSULATED TYPE

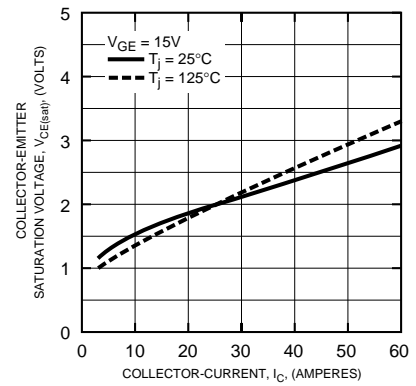
OUTPUT CHARACTERISTICS (TYPICAL)



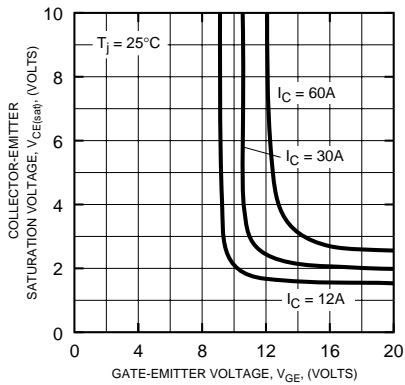
TRANSFER CHARACTERISTICS (TYPICAL)



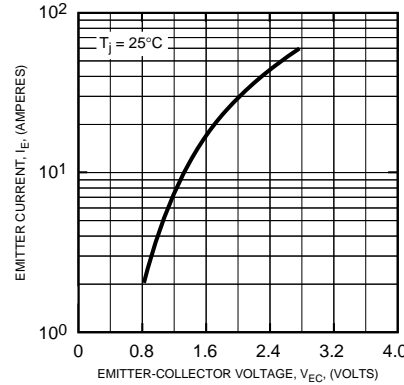
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



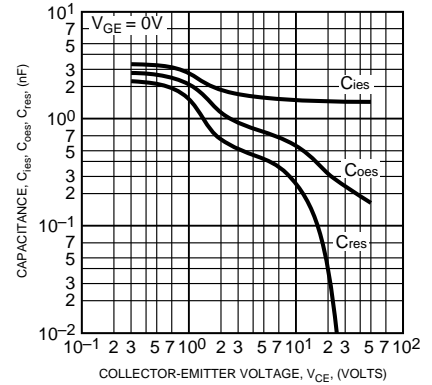
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



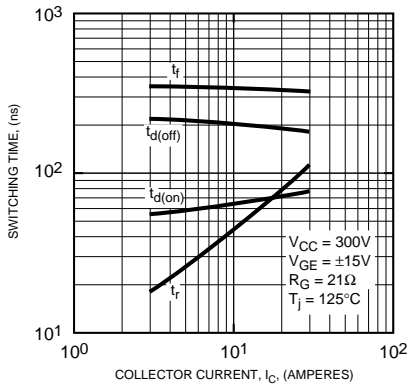
FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



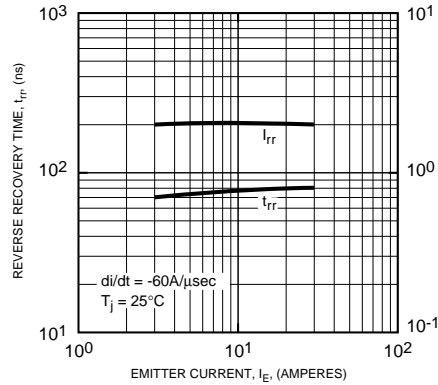
CAPACITANCE VS. V_{CE} (TYPICAL)



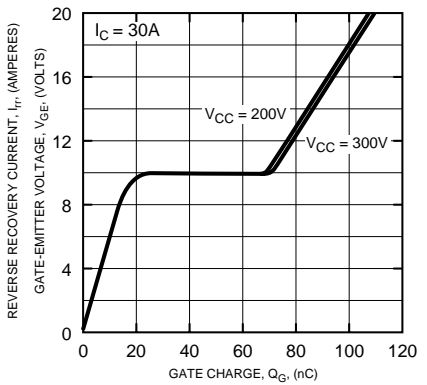
HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)



REVERSE RECOVERY CHARACTERISTICS (TYPICAL)



GATE CHARGE, V_{GE}



CM30TF-12H

MEDIUM POWER SWITCHING USE
INSULATED TYPE

